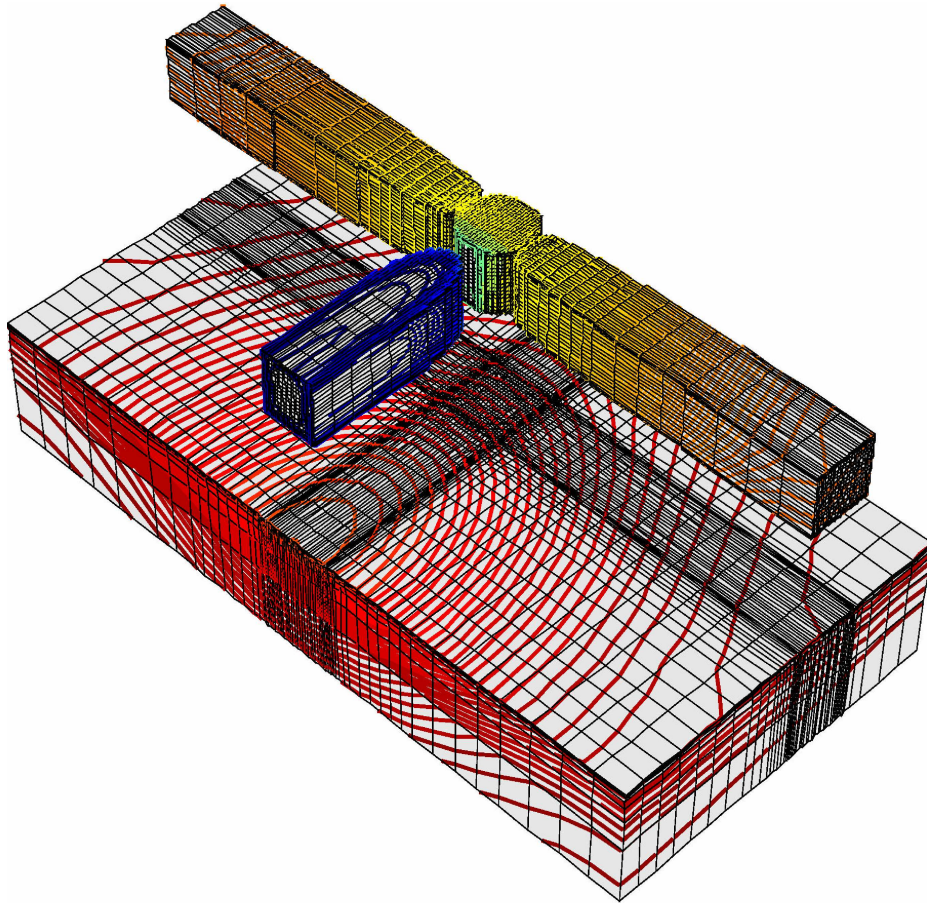


Quantum transport effects and their modeling



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Fabian Bufler
Andreas Schenk
Wolfgang Fichtner

SNDT Taiwan, May 2004



Outline

- ★ Motivation
- ★ Overview: Simulation models
- ★ “Conventional” device simulation
- ★ Classical Monte-Carlo simulation
 - Treatment of non-localities
 - Strained silicon devices
- ★ Modeling of quantum effects
- ★ Conclusion

Motivation

- ★ Scaling is the driving force behind the semiconductor revolution

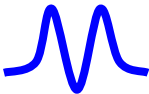


YEAR	1999	2002	2005	2008	2011	2014
TECHNOLOGY NODE (nm)	180	130	100	70	50	35

Physical gate length: 9 nm

- ★ Reduced device dimensions require refined simulation models:
 - higher fields \Rightarrow non-local transport effects
 - quantum mechanics

G.E.Moore, *Electronics*, **38**(8) (1965); M.Lundstrom, *Science* **299**, 210 (2003)

A Taxonomy of Simulation Models

	near equilibrium dissipative (local mobility)	quasi-ballistic	fully ballistic
quantum mechanics  $-\frac{\hbar^2}{2m} \nabla^2$	Quantum drift-diffusion	NEGF with Büttiker probes Wigner eq ⁿ	NEGF without Σ_{scatter} Scattering matrix
classical mechanics 	Drift-diffusion  Hydro	Boltzmann eq ⁿ (full band MC)	scattering free Boltzmann (analytic)

The Boltzmann Transport Equation (BTE)

$$\left(\frac{\partial}{\partial t} + \mathbf{v}(\mathbf{k}) \cdot \nabla_{\mathbf{r}} - \frac{e}{\hbar} \mathbf{E}(\mathbf{r}) \cdot \nabla_{\mathbf{k}} \right) f(\mathbf{r}, \mathbf{k}, t) = \left(\frac{df}{dt} \right)_{\text{coll}}$$

★ Device simulation is based on the **kinetic theory of gases**.

★ Dynamic variable:
Classical distribution function

$$f(\mathbf{r}, \mathbf{k}, t) d^3r d^3k = \#(\text{particles in } d^3r d^3k)$$

The “Conventional” Simulation Models

★ BTE: integro–differential eqⁿ over \mathbb{R}^7 .

⇒ Numerical effort rather high.

★ Reduce effort by the **Method of Moments**

- **New dynamic variables:**

\mathbf{k} –averages of $\otimes^n \mathbf{v}(\mathbf{k}) f(\mathbf{r}, \mathbf{k}, t)$

- Use only the (two) **lowest moments**.

- Introduce a **local** parameterization of μ .

⇒ **Hydrodynamic eqⁿs / Drift–Diffusion eqⁿs**

Limitations of the “Conventional” Models

★ Assumptions

- local thermal equilibrium
- v_{mean} is a function of local quantities.

✗ fail in very small devices:

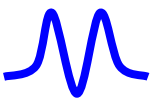

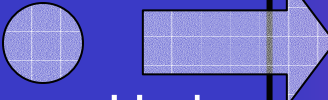
✗ not enough scattering for local thermalization

✗ ballistic contributions to v_{mean} —

electron velocity depends on the history

⇒ velocity overshoot.

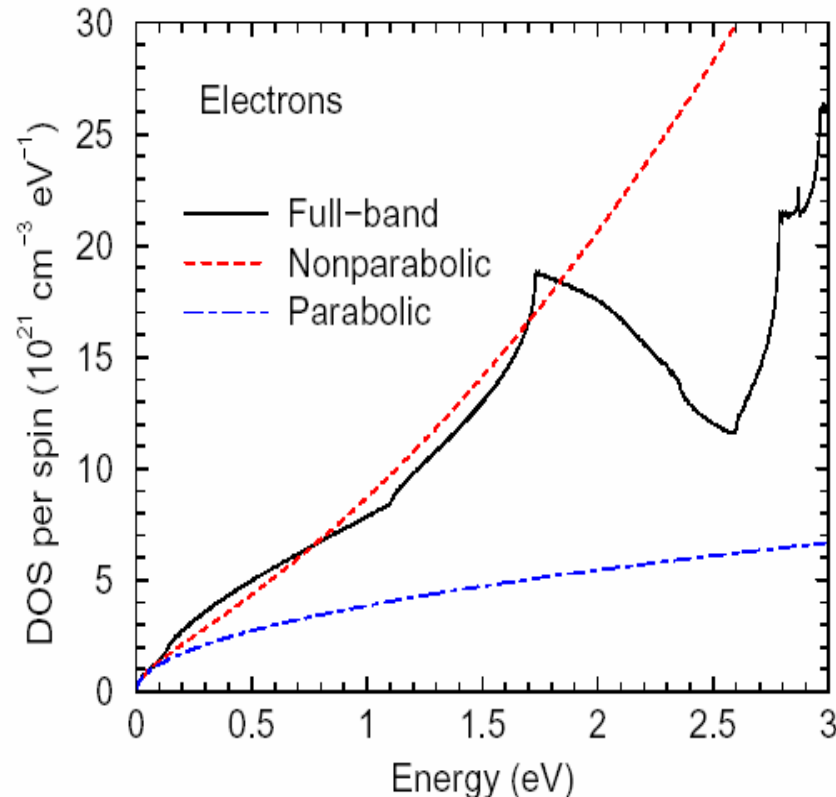
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Direct Solution of the Boltzmann equation

- ★ Characteristics of the Boltzmann equation:
 - High dimensionality of the space of possible f ,
 - Stochastic nature of the scattering term.
- ✘ Direct discretization problematic / inefficient.
- ✓ Monte–Carlo methods well suited.

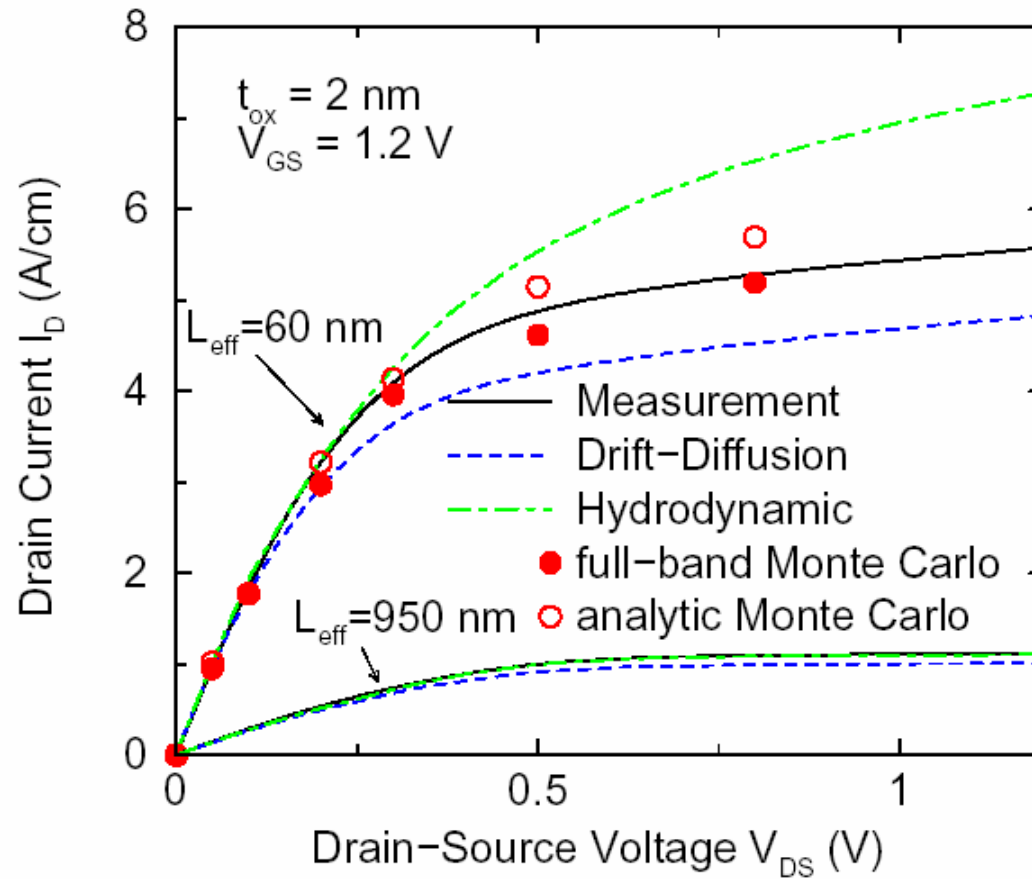
Density-of-States DOS



$$\mathcal{D}(\epsilon) = \frac{1}{(2\pi)^3} \int_{\epsilon(\mathbf{k})=\epsilon} \frac{dF}{|\nabla_{\mathbf{k}}\epsilon(\mathbf{k})|} = \frac{1}{(2\pi)^2} \left(\frac{2m}{\hbar^2}\right)^{3/2} \sqrt{\epsilon}$$

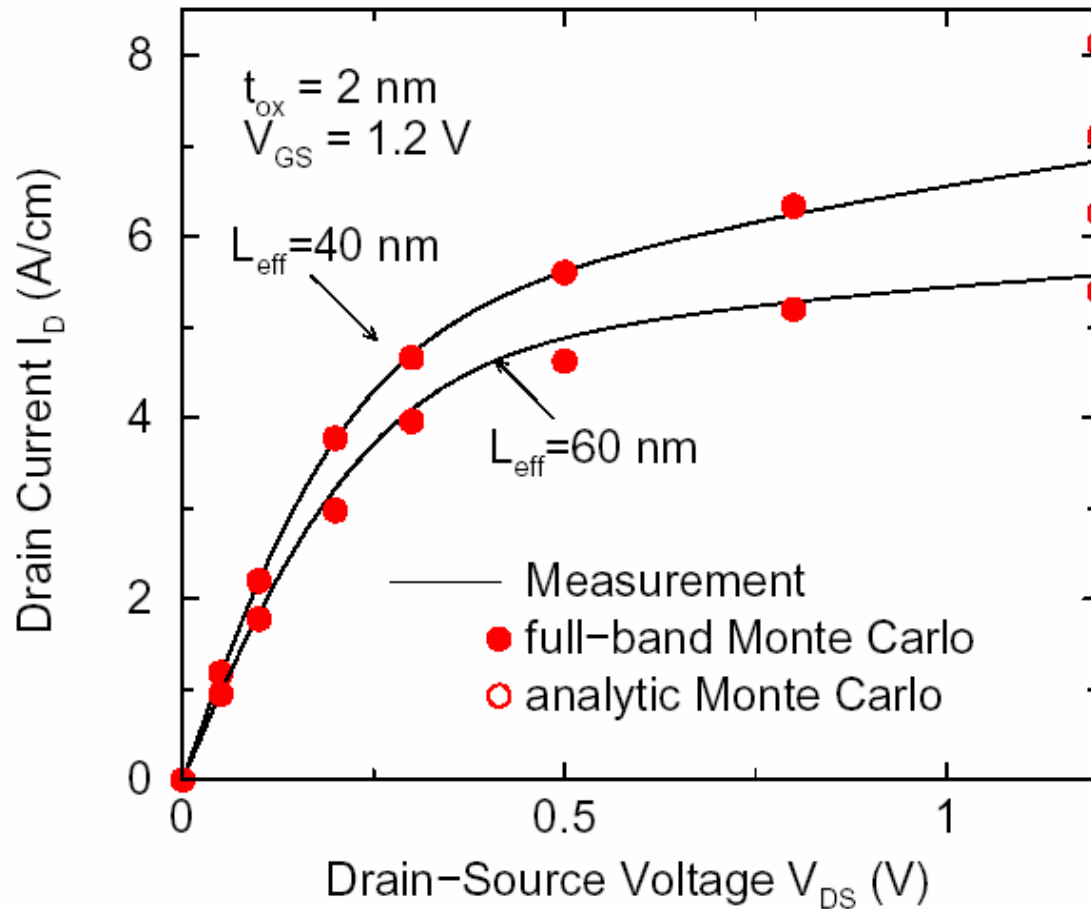
→ phonon scattering rate (isotropic and parabolic)

Output Characteristics



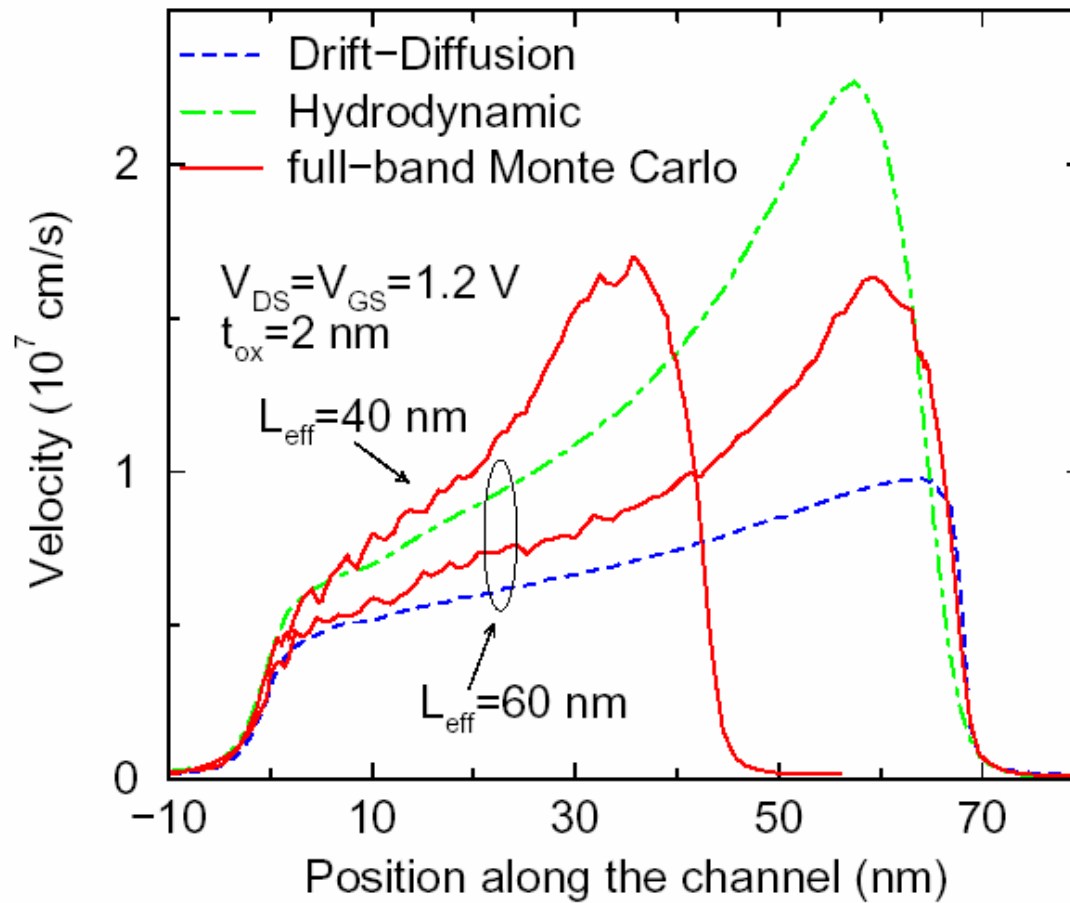
Different simulation models

Output Characteristics



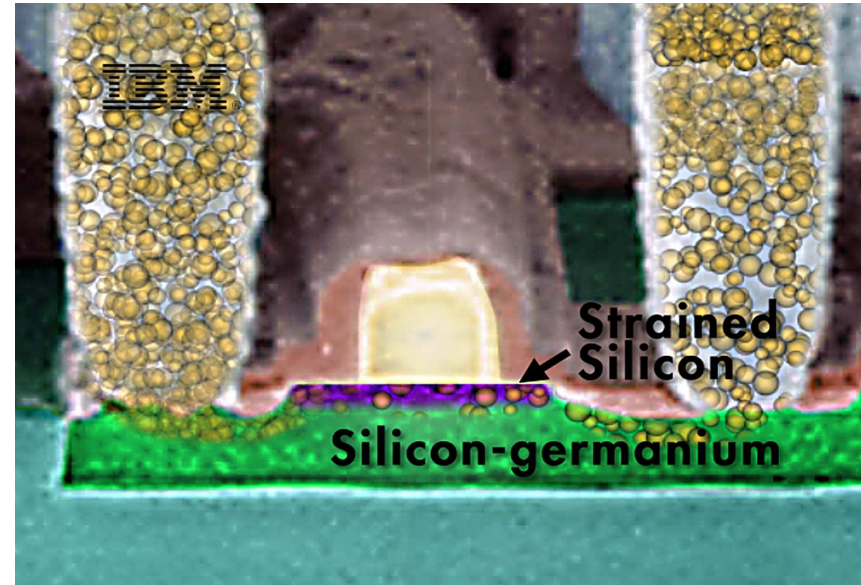
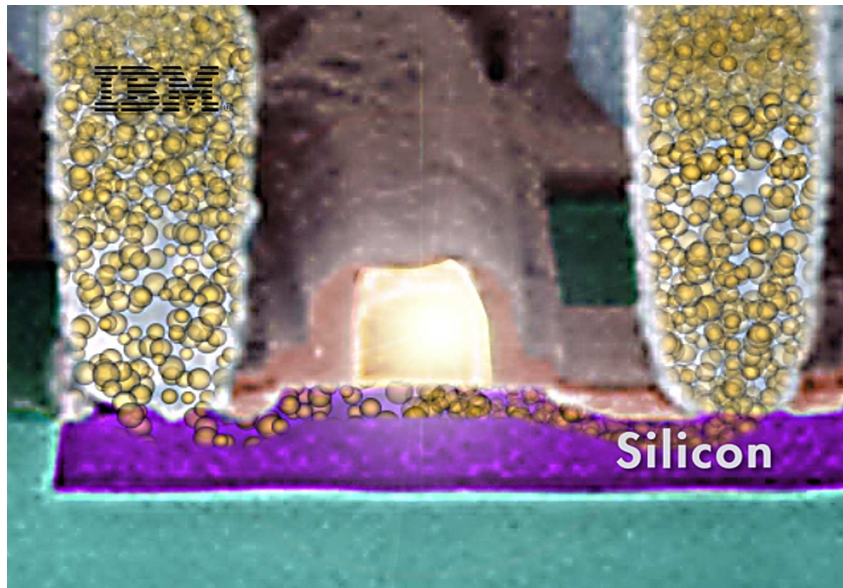
Different gate lengths

Velocity Profiles along the Channel



Velocity in source-side of channel determines on-current

Strained Silicon

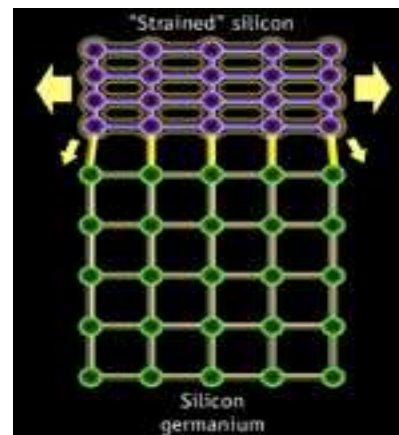
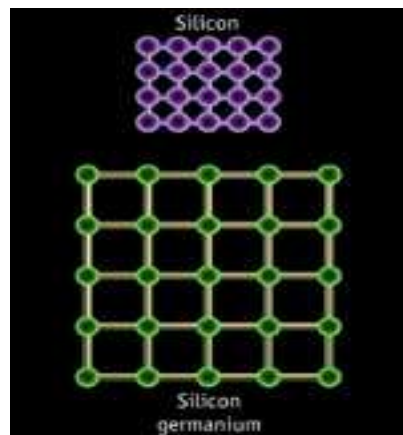


Silicon–Germanium and strained Silicon are now heavily used in semiconductor industry

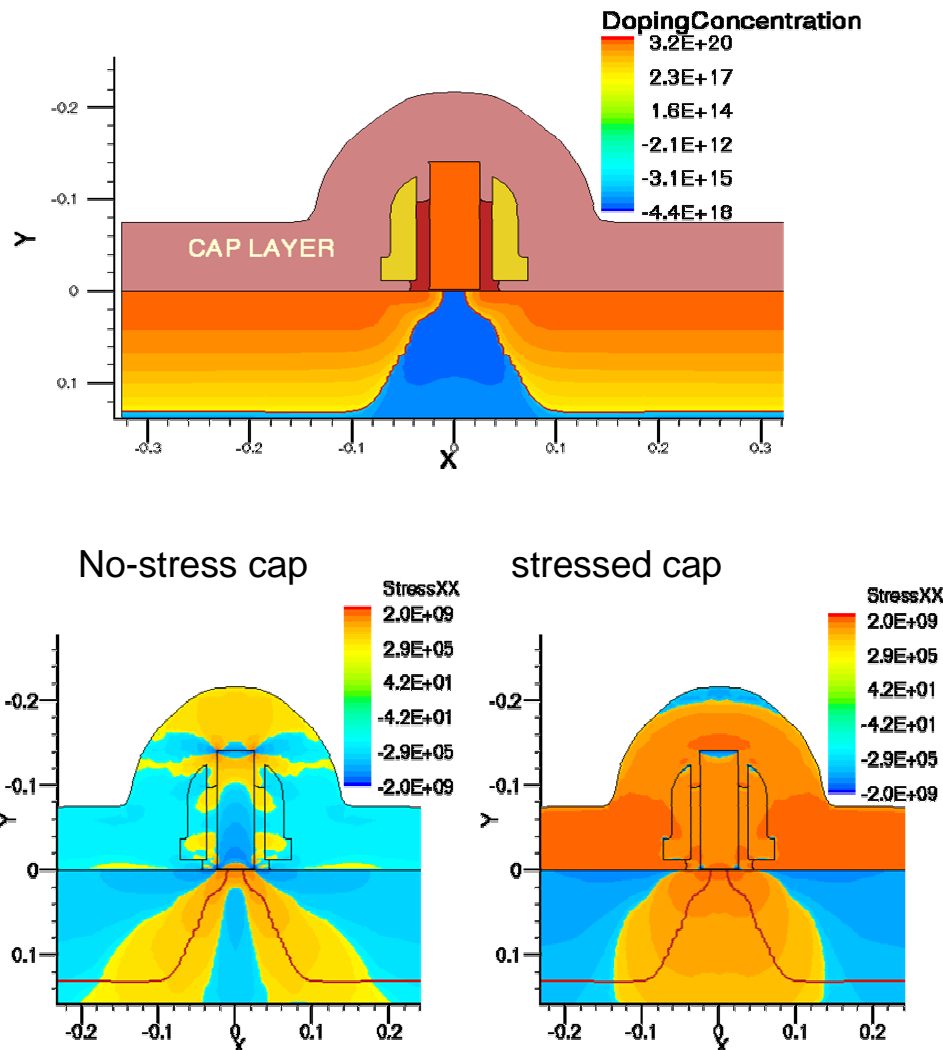
- ★ compute the mobility by bulk Monte–Carlo
[input: band-structure of strained Si]

SiGe and strained Si Lattice constant

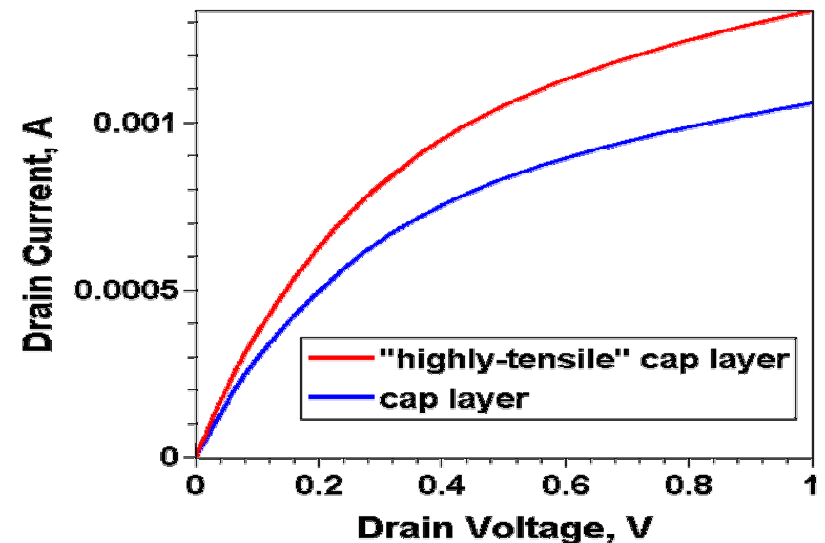
- ★ Silicon: 5.43 Å
- ★ Germanium: 5.66 Å
- ★ $\text{Si}_{1-x}\text{Ge}_x$: depends on the mole-fraction x .
- ★ Lattices of deposited layer will naturally adapt:
 - SiGe on top of Silicon is under compressive stress
 - Silicon on top of SiGe is **stretched**
 - *increased mobility !!!*



Strained CMOS – Strain in the Cap Layer

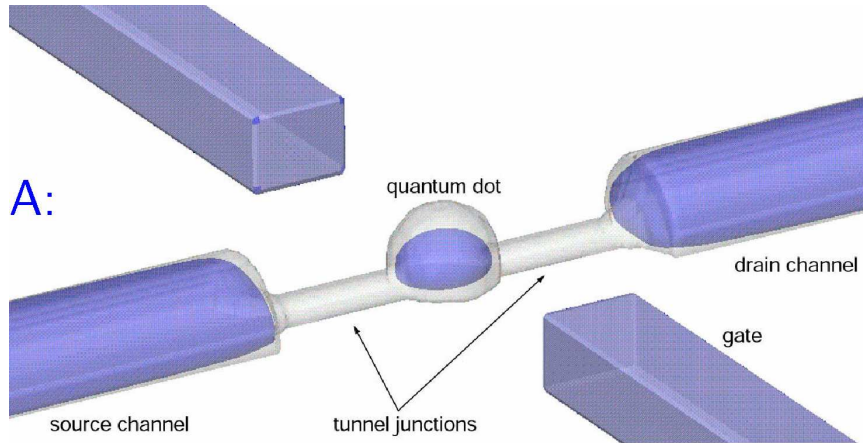


High **tensile** stress in the **cap layer** results in **compressive** stress in **source** and **drain** and **tensile** stress in the **channel**.

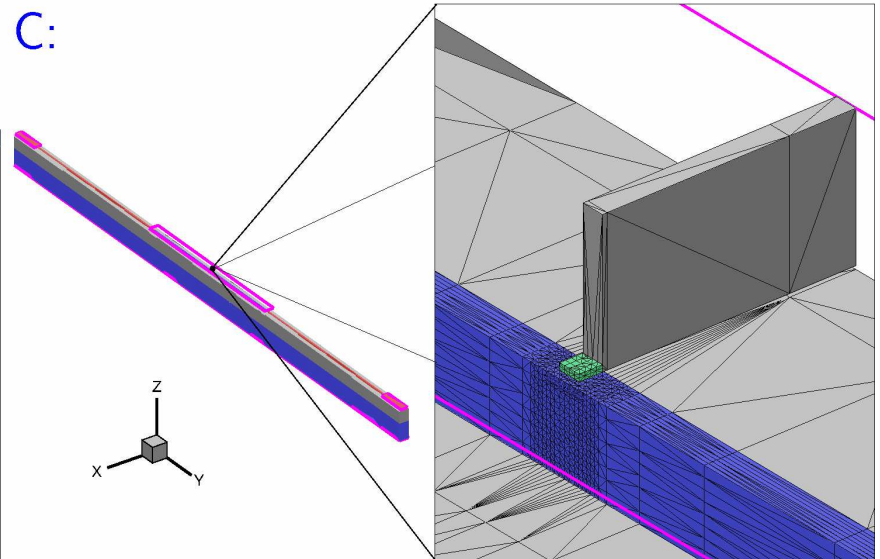
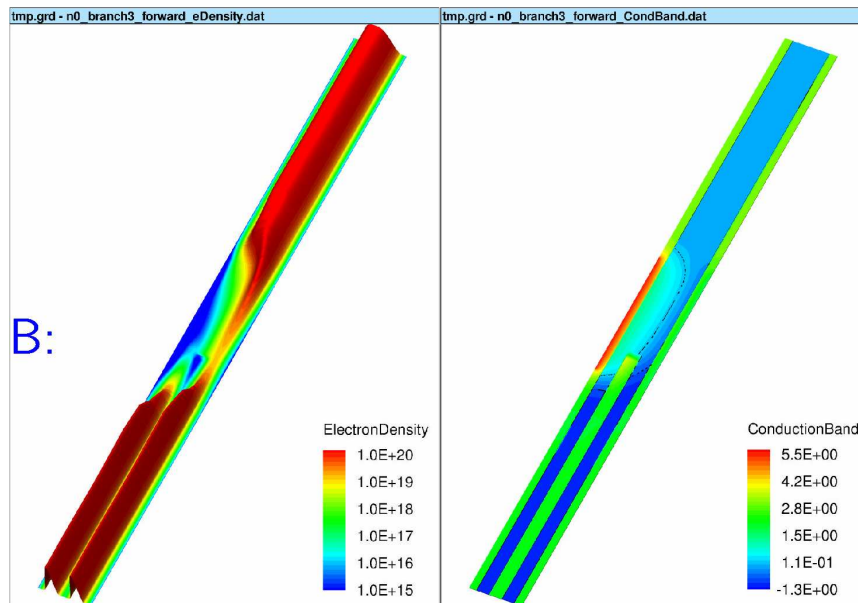


The NMOS with the highly tensile stress cap layer shows an improved saturation current (approx. 14%).

Quantum mechanics becomes important!

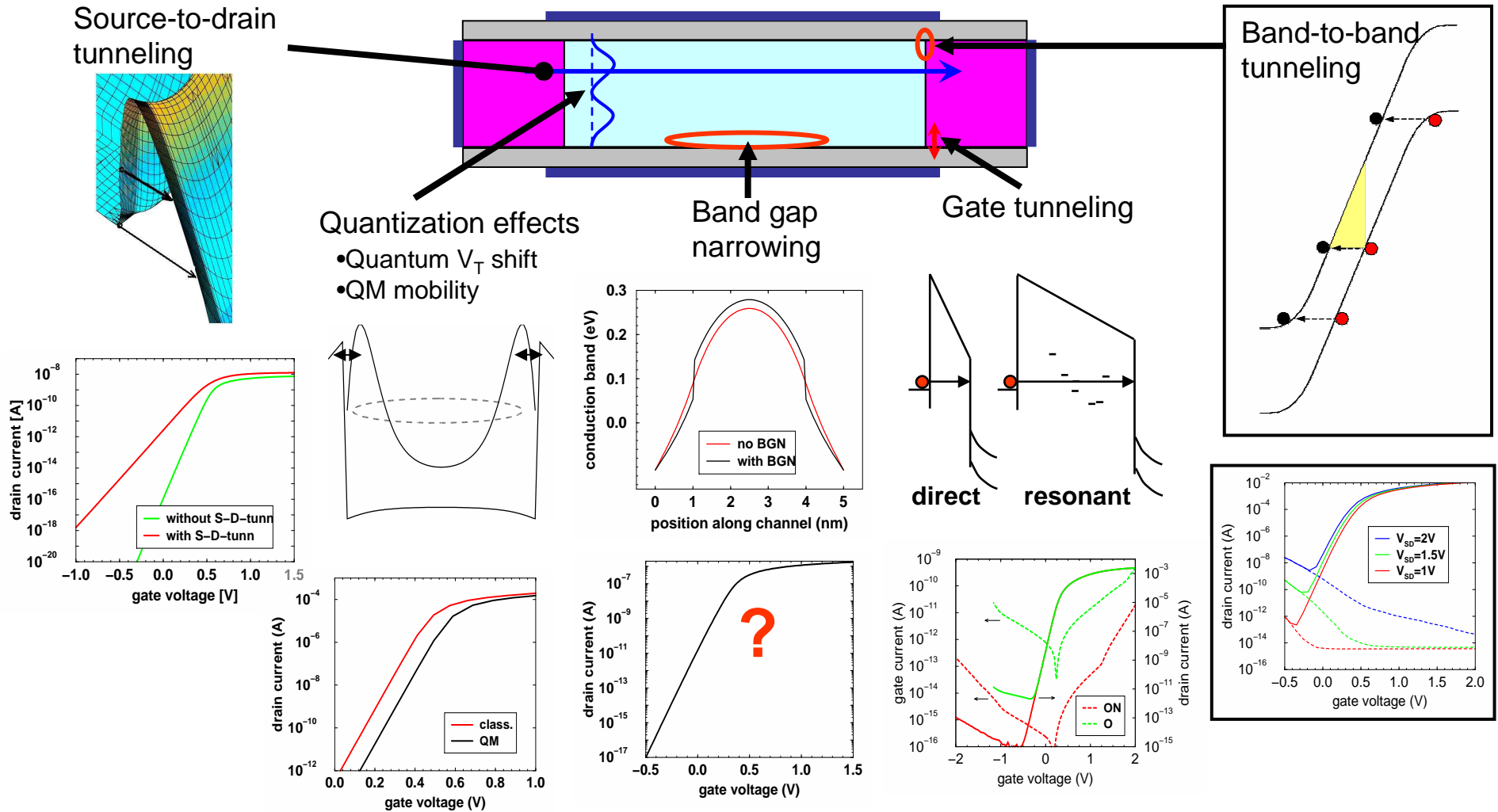


Nanodevices have
“critical dimensions”
comparable with the
electron wavelength.

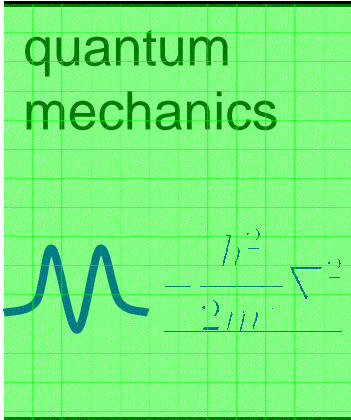
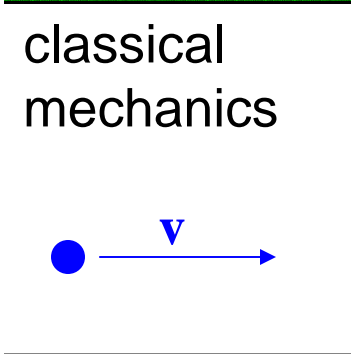


- A: Single electron transistors
- B: Quantum-ballistic devices
- C: QD flash memory

Five quantum effects



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Quantum Ballistic Transport

★ Coherent transport

- \nexists inelastic scattering.
- An e^- remains in a fixed Ψ (solution of Schrödinger eqⁿ).
- When occupied, Ψ carries a current $I(\Psi) \propto$ transmission probability $T(\epsilon)$.

★ Thermal carrier injection at the contacts.

⇒ Landauer–Büttiker formula:

from open boundary Schrödinger eqⁿ

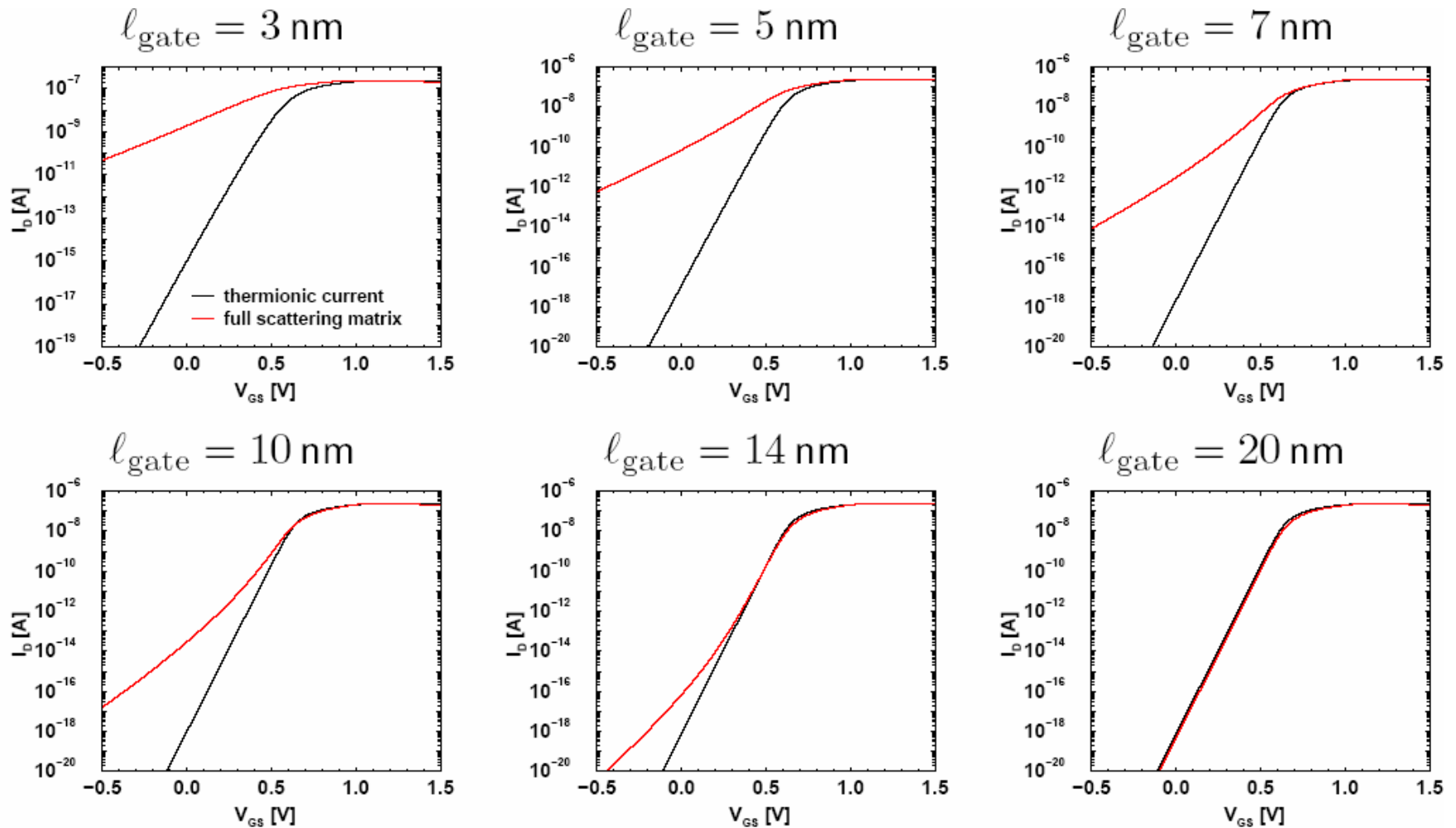
$$I = -\frac{2e}{h} \sum_{v,i} \int_{\epsilon_{v,i}^0}^{\infty} d\epsilon T_{v,i}(\epsilon) \left(f(\beta(\epsilon - \epsilon_{\text{Fermi}}^{\text{src}})) - f(\beta(\epsilon - \epsilon_{\text{Fermi}}^{\text{drn}})) \right) \quad \underline{1D}$$

$$I = -\frac{2e}{h} \sqrt{\pi} \frac{W}{\lambda_{\text{th}}} \sum_{v,i} \int_{\epsilon_{v,i}^0}^{\infty} d\epsilon T_{v,i}(\epsilon) \left(\mathfrak{F}_{-\frac{1}{2}}(\beta(\epsilon_{\text{Fermi}}^{\text{src}} - \epsilon)) - \mathfrak{F}_{-\frac{1}{2}}(\beta(\epsilon_{\text{Fermi}}^{\text{drn}} - \epsilon)) \right) \quad \underline{2D}$$

W : width of the device

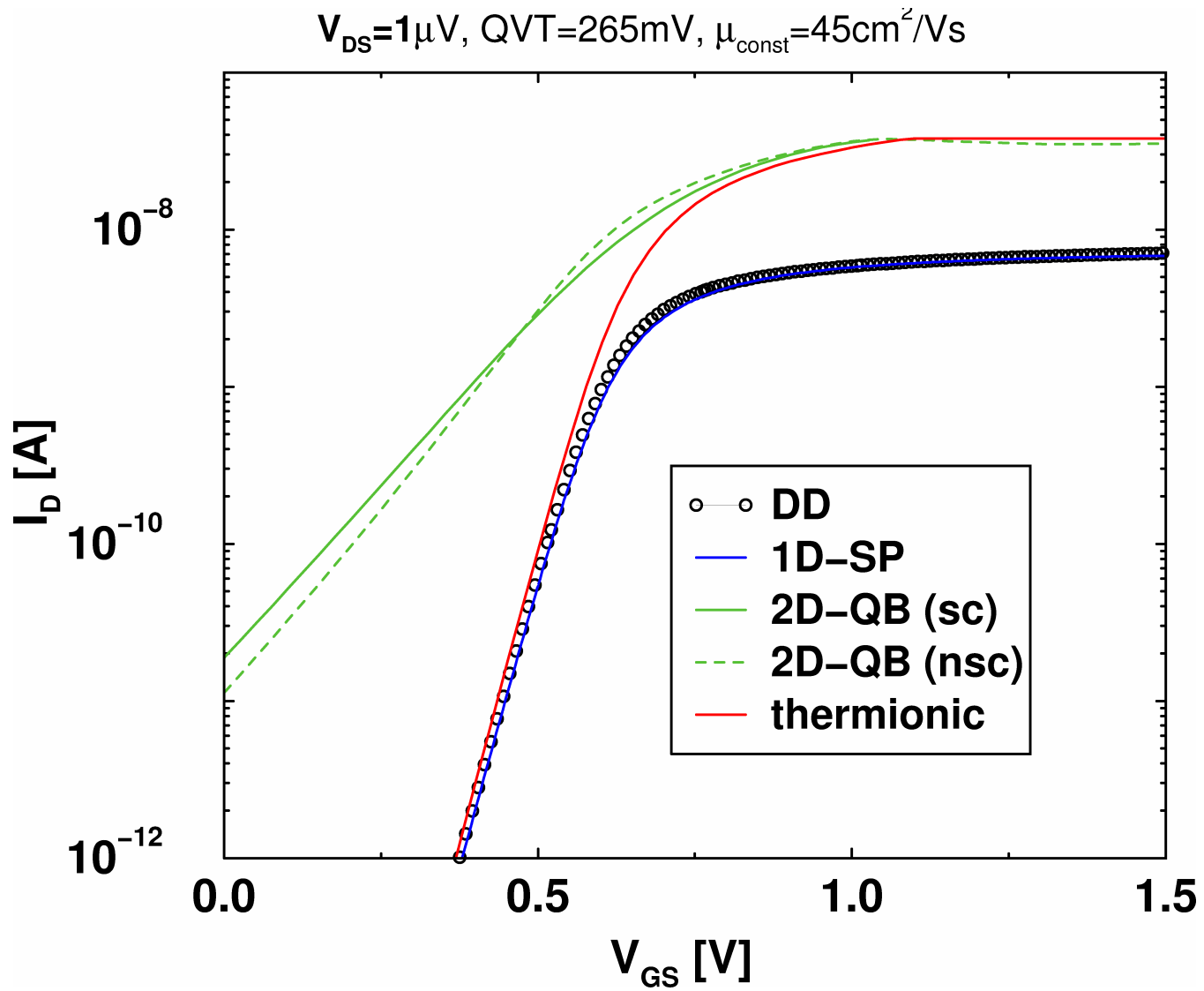
λ_{th} : electron thermal wave-length $h/\sqrt{2m^*k_{\text{B}}T}$

Source–Drain Tunneling in nano–MOSFETS



double–gate MOSFETs with a Si body thickness of 1 nm ($V_{sd} = 1 \mu\text{V}$).

Model comparison ($L_{\text{gate}} = 5\text{nm}$)



Simulation of Quantum-Dot Flash RAM

⇒ Challenge: Devices with quantum dots **and** classical channels.

× **SIMNAD** **cannot** handle dissipative transport . . .

✓ . . . but **DESSIS** **can** !

DESSIS has a 1D Schrödinger solver and a QDD facility, but

× it **cannot** handle multi-dimensional confinement properly. . .

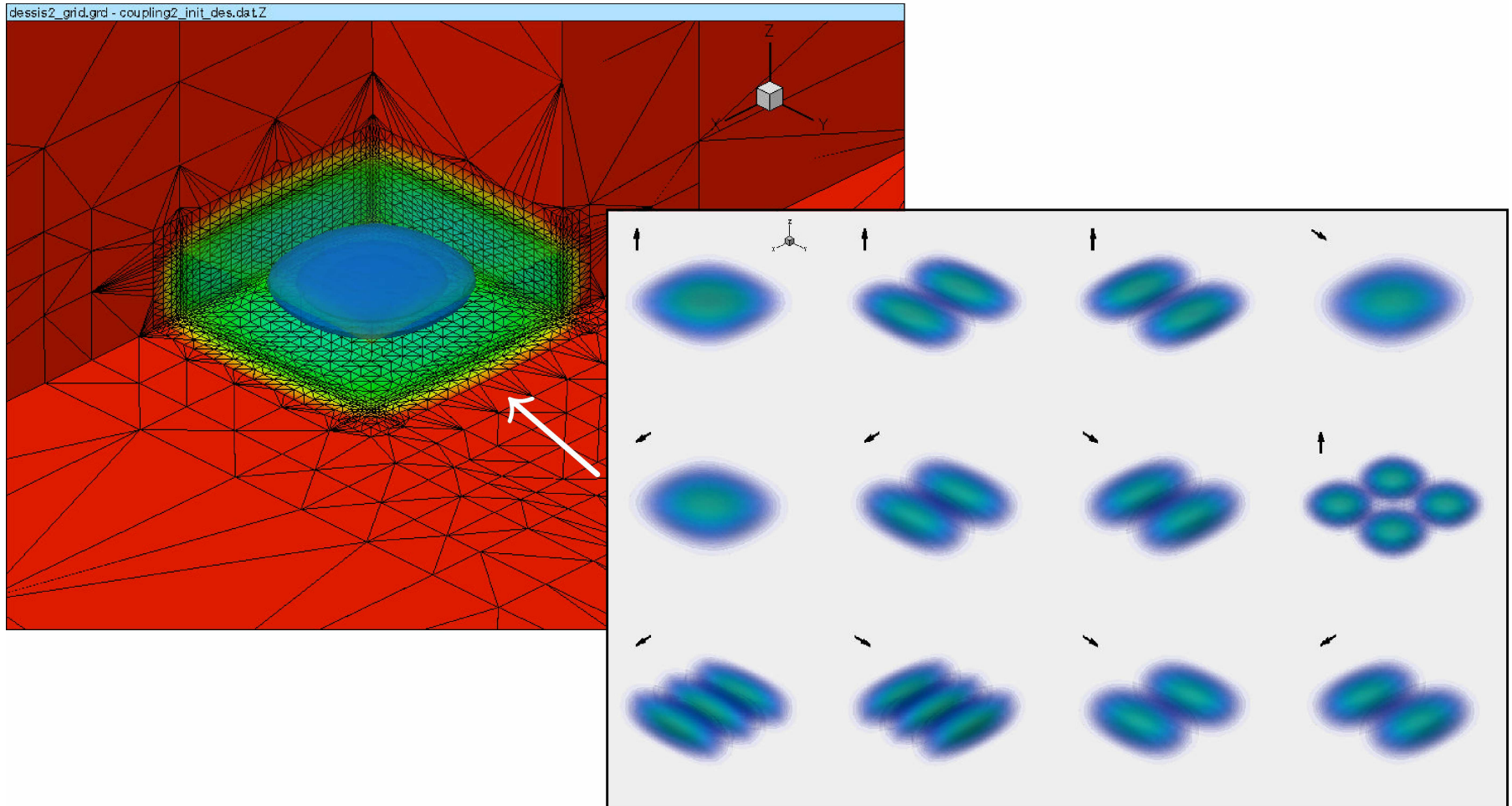
✓ . . . but **SIMNAD** **can** !

★ **Together, the two simulators can do both !**

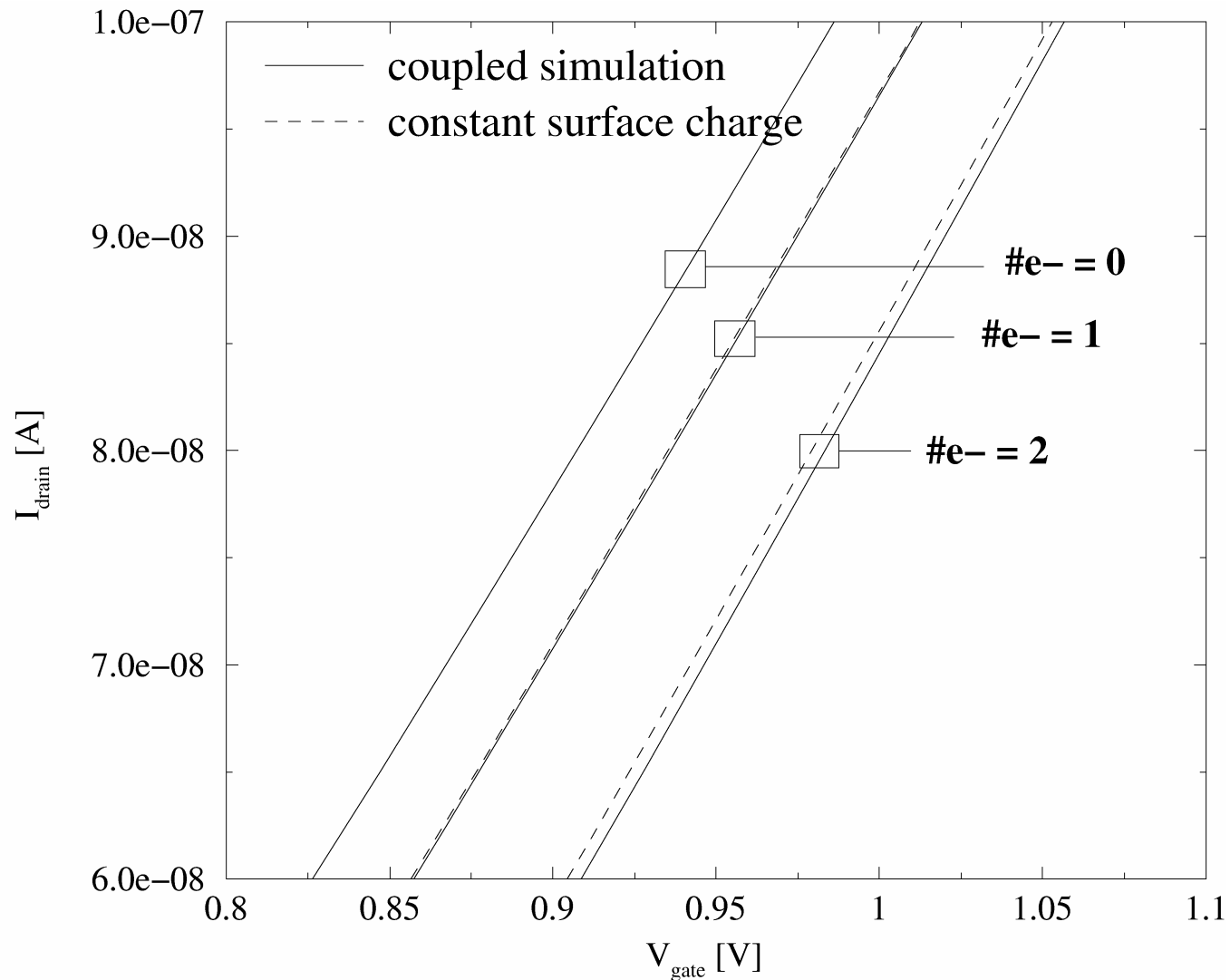
⇒ Apply a **simulator coupling** scheme !

Coupled DESSIS/SIMNAD Simulations

Simulator coupling: **SIMNAD** charge density on **DESSIS** mesh:



Coupled DESSIS/SIMNAD Results



Conclusion

- ★ Downscaling of devices \Rightarrow non-local phenomena
- ★ Two kinds of non-localities
 - classical: ballistic transport; non-local μ
 - quantum: wave-nature of the carriers
- ★ classical non-localities: full band MC ☺
- ★ quantum mechanics: ☺/☹
simplifications necessary (high comp. effort)
- ★ DESSIS/SIMNAD coupling:
quantum dots **and** classical channels in one device

Acknowledgments

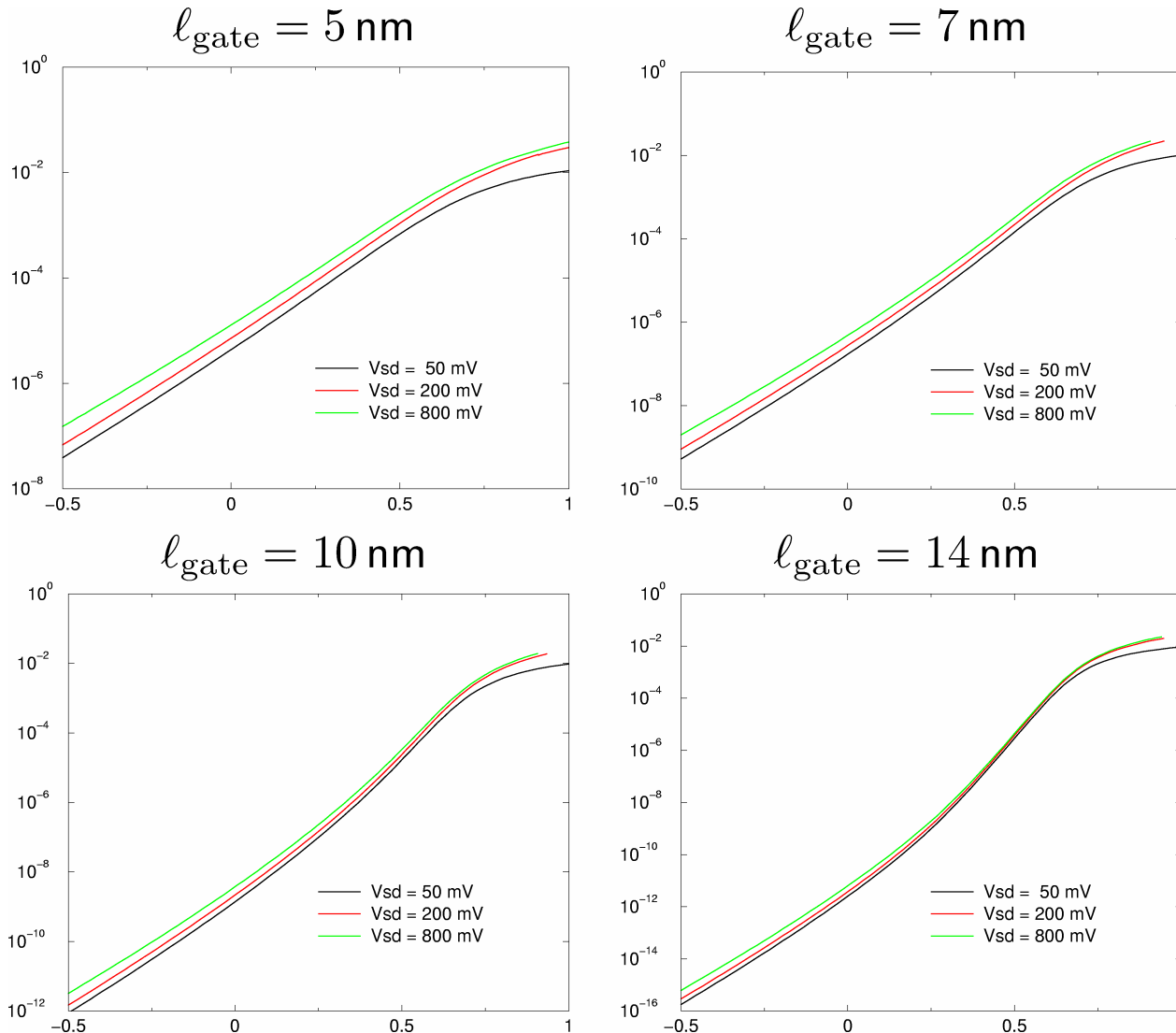
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Thank you !

Ballistic MOSFET under forward bias



Quantum
ballistic current
for different
source-drain
voltages
[in $A/\mu m$]